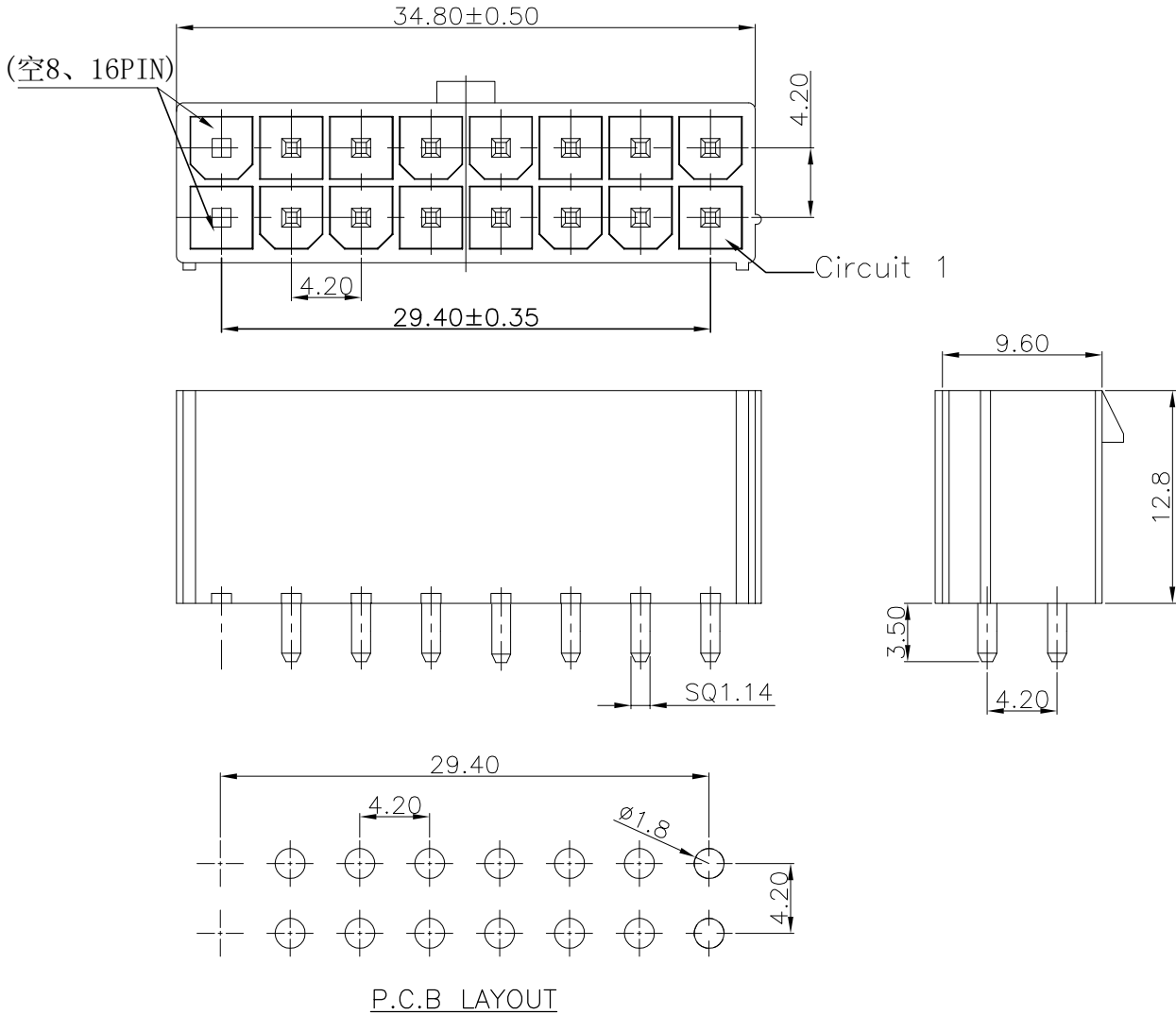


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: PA66
1-2.CONTACTS: BRASS
2.PLATING SPECIFICATION:
2-1.CONTACTS:
TIN/GOLD FLASH PLATED OVER ALL.
3.ELECTRICAL PERFORMANCE:
3-1.CURRENT RATING: 9A AC/DC
3-2.CONTACT RESISTANCE: 10 mΩ MAX
3-3.INSULATION RESISTANCE: 1000MΩ Min
3-4.DIELECTRIC WITHSTANDING : 1500V
4.ENVIRONMENTAL PERFORMANCE:
4-1.OPERATING TEMPERATURE: -25°C~+85°C.
5.PACKAGE SPEC: PE BAG
6.P/N:

△A1

SERIES NO:

C4201

CONNECTOR:

W

ANGLE:

0

8-TYPE

8-2

ROW NO:

XX

2-DOUBLE ROW

1

PIN Q'PY:

X

16

X

X

X

HOUSING:

0-UL94V-0

2-UL94V-2

COLOR:

A-BLACK

S-NATURE

PLATING:

C-BRIGHT TIN

TERMIPOINT:

1-DIP

H	REV.		REVISION RECORD		DATE			GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: C4201W08-2XX1XXX		DWG.NO: ENDE05		 WanLian Technology Co., Ltd		H				
	A0		NEW RELEASE		21.11.17			LINEAR	ANGLES	APPROVED	Wang_jr	23.09.11											
	A1		PART NUMBER RENEWAL		23.09.11		0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	23.09.11	TITLE: Pitch 4.2mm 双排 180° DIP Wafer 实心针 2X8P 空第8, 16P											
							UNIT:mm	0.00±0.25	X°±3°	DRAWN	LX_HOU			23.09.11									
							SIZE: A4	0.000±0.10	X°X' ±2°														
1			2			3			4			5			6			7			8		